

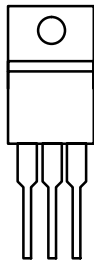


N-Channel 40-V (D-S) 175°C MOSFET

PRODUCT SUMMARY

$V_{(BR)DSS}$ (V)	$r_{DS(on)}$ (Ω)	I_D (A)
40	0.004 @ $V_{GS} = 10$ V	85 ^a

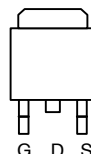
TO-220AB

G D S
Top View

Ordering Information
SUP85N04-04
SUP85N04-04—E3 (Lead (Pb)-Free)

DRAIN connected to TAB

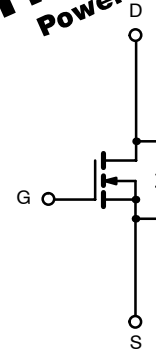
TO-263



Top View

Ordering Information
SUP85N04-04
SUP85N04-04—E3 (Lead (Pb)-Free)

175°C Rated
Maximum Junction Temperature
TrenchFET®
Power MOSFETs



N-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS ($T_C = 25^\circ\text{C}$ UNLESS OTHERWISE NOTED)

Parameter		Symbol	Limit	Unit
Drain-Source Voltage		V_{DS}	40	V
Gate-Source Voltage		V_{GS}	20	
Continuous Drain Current ($T_J = 175^\circ\text{C}$)	$T_C = 25^\circ\text{C}$	I_D	85 ^a	A
	$T_C = 125^\circ\text{C}$		85 ^a	
Pulsed Drain Current		I_{DM}	240	
Avalanche Current		I_{AR}	70	
Repetitive Avalanche Energy ^b	$L = 0.1$ mH	E_{AR}	211	mJ
Maximum Power Dissipation ^b	$T_C = 25^\circ\text{C}$ (TO-220AB and TO-263)	P_D	250 ^c	W
	$T_A = 25^\circ\text{C}$ (TO-263) ^d		3.75	
Operating Junction and Storage Temperature Range		T_J, T_{stg}	-55 to 175	$^\circ\text{C}$

THERMAL RESISTANCE RATINGS

Parameter		Symbol	Limit	Unit
Junction-to-Ambient	PCB Mount (TO-263) ^d	R_{thJA}	40	$^\circ\text{C/W}$
	Free Air (TO-220AB)		62.5	
Junction-to-Case		R_{thJC}	0.6	

Notes

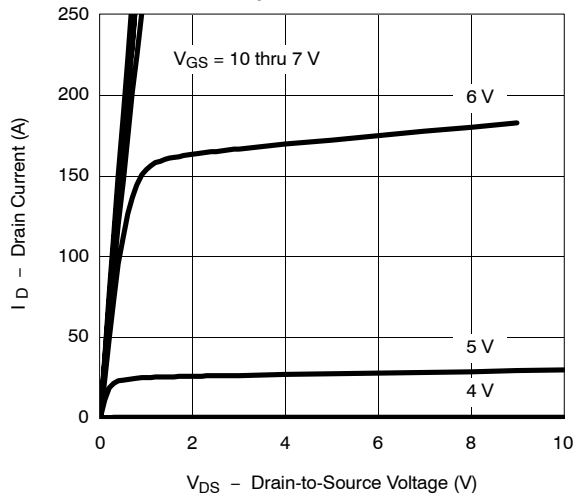
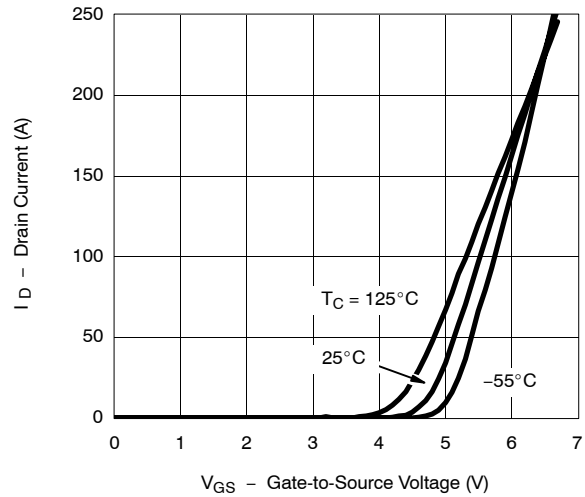
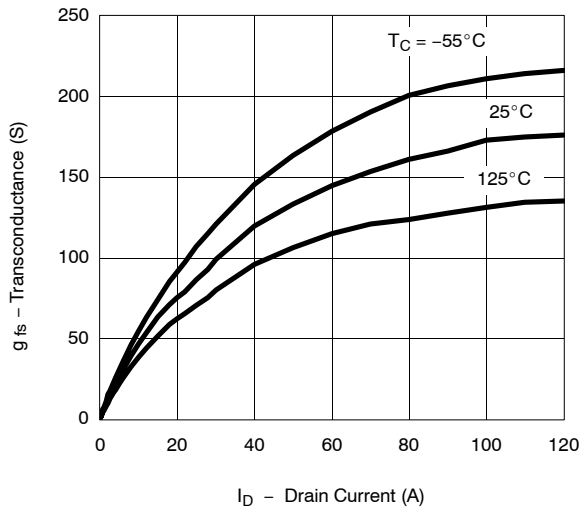
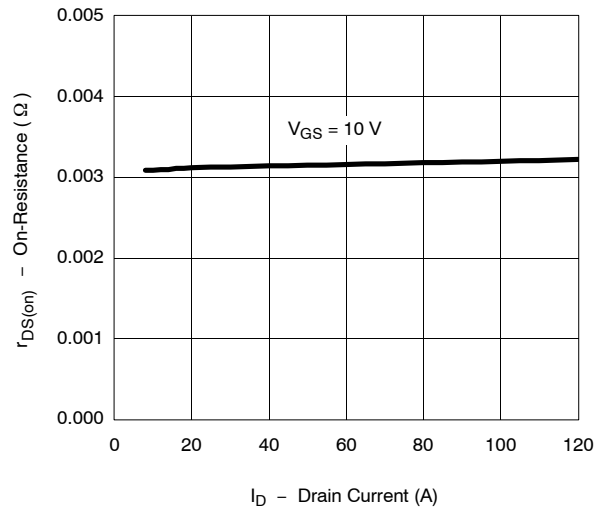
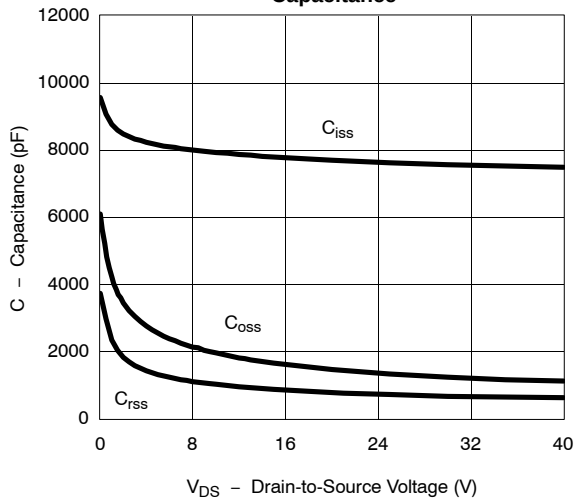
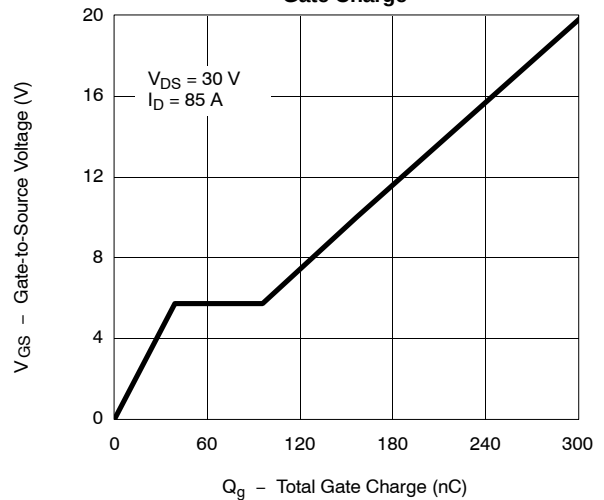
- Package limited.
- Duty cycle $\leq 1\%$.
- See SOA curve for voltage derating.
- When mounted on 1" square PCB (FR-4 material).

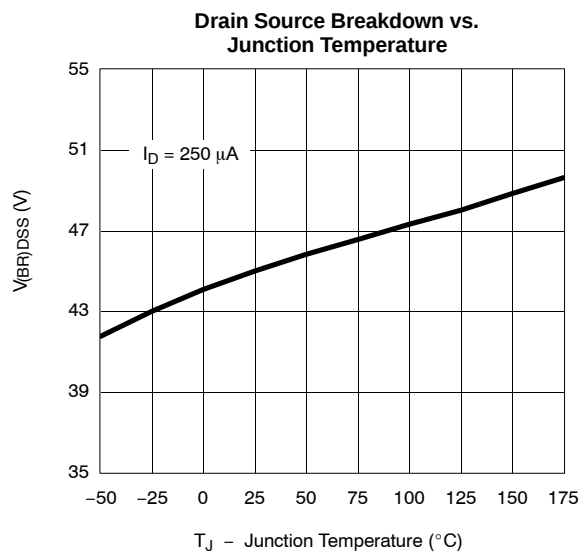
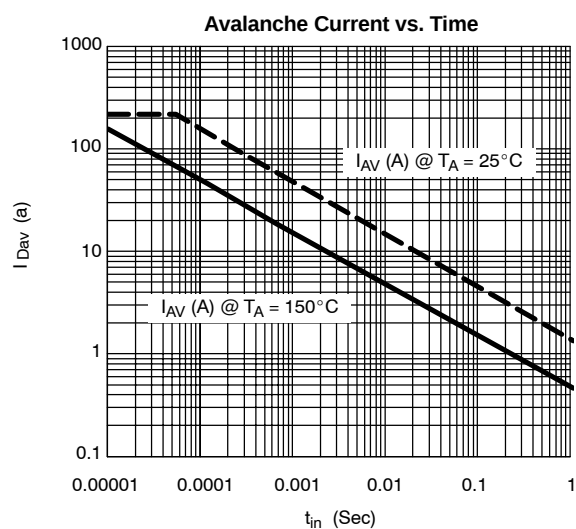
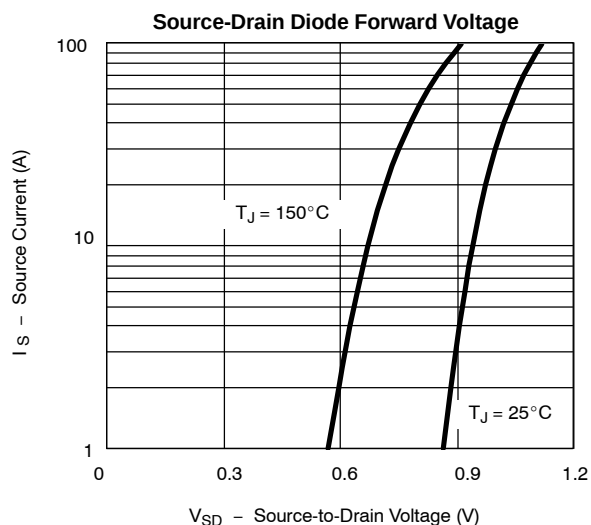
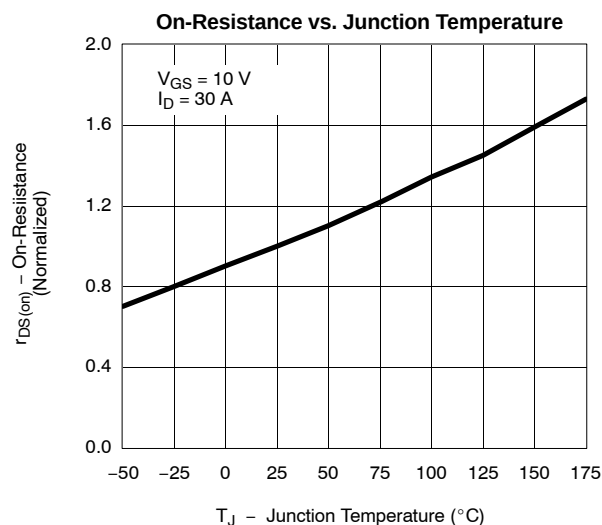
SPECIFICATIONS (T_J = 25 °C UNLESS OTHERWISE NOTED)

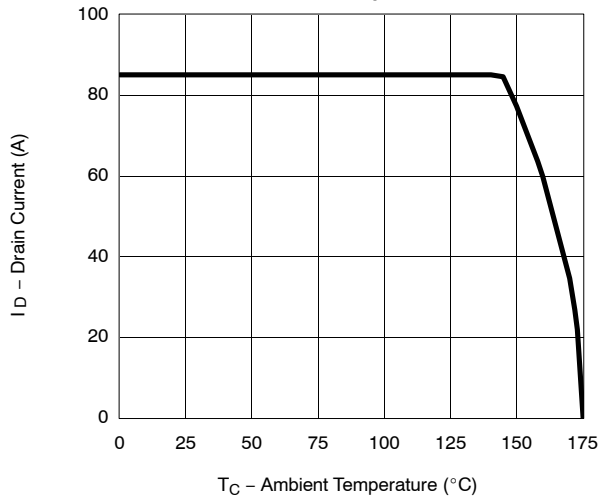
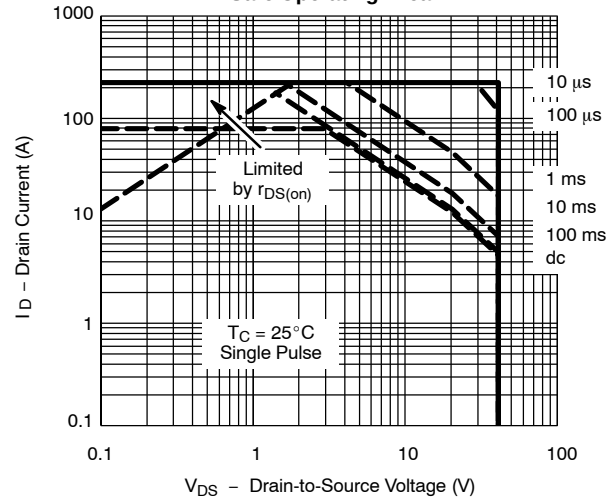
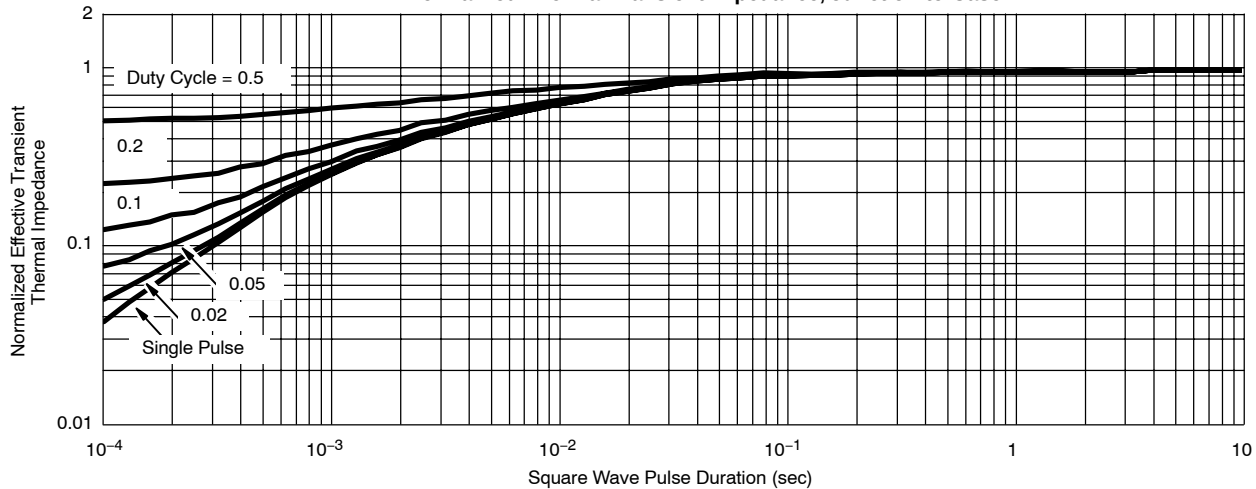
Parameter	Symbol	Test Condition	Min	Typ	Max	Unit
Static						
Drain-Source Breakdown Voltage	V _{(BR)DSS}	V _{DS} = 0 V, I _D = 250 μA	40			V
Gate-Threshold Voltage	V _{GS(th)}	V _{DS} = V _{GS} , I _D = 250 μA	2		4	
Gate-Body Leakage	I _{GSS}	V _{DS} = 0 V, V _{GS} = 20 V			100	nA
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = 40 V, V _{GS} = 0 V			1	μA
		V _{DS} = 40 V, V _{GS} = 0 V, T _J = 125°C			50	
		V _{DS} = 40 V, V _{GS} = 0 V, T _J = 175°C			250	
On-State Drain Current ^a	I _{D(on)}	V _{DS} ≥ 5 V, V _{GS} = 10 V	120			A
Drain-Source On-State Resistance ^a	r _{DS(on)}	V _{GS} = 10 V, I _D = 30 A		0.0031	0.004	Ω
		V _{GS} = 10 V, I _D = 30 A, T _J = 125°C			0.0055	
		V _{GS} = 10 V, I _D = 30 A, T _J = 175°C			0.007	
Forward Transconductance ^a	g _{fs}	V _{DS} = 15 V, I _D = 30 A	30			S
Dynamic ^b						
Input Capacitance	C _{iss}	V _{GS} = 0 V, V _{DS} = 25 V, f = 1 MHz		7620		pF
Output Capacitance	C _{oss}			1325		
Reverse Transfer Capacitance	C _{rss}			710		
Total Gate Charge ^c	Q _g	V _{DS} = 30 V, V _{GS} = 10 V, I _D = 85 A		160	250	nC
Gate-Source Charge ^c	Q _{gs}			40		
Gate-Drain Charge ^c	Q _{gd}			55		
Turn-On Delay Time ^c	t _{d(on)}	V _{DD} = 30 V, R _L = 0.47 Ω I _D ≅ 85 A, V _{GEN} = 10 V, R _g = 2.5 Ω		20	35	ns
Rise Time ^c	t _r			115	175	
Turn-Off Delay Time ^c	t _{d(off)}			75	115	
Fall Time ^c	t _f			85	130	
Source-Drain Diode Ratings and Characteristics (T _C = 25°C) ^b						
Continuous Current	I _S				85	A
Pulsed Current	I _{SM}				240	
Forward Voltage ^a	V _{SD}	I _F = 85 A, V _{GS} = 0 V		1.1	1.4	V
Reverse Recovery Time	t _{rr}	I _F = 85 A, di/dt = 100 A/μs		60	90	ns
Peak Reverse Recovery Current	I _{RM(REC)}			2.6	4	A
Reverse Recovery Charge	Q _{rr}			0.08	0.15	μC

Notes

- a. Pulse test; pulse width ≤ 300 μs, duty cycle ≤ 2%.
b. Guaranteed by design, not subject to production testing.
c. Independent of operating temperature.

**TYPICAL CHARACTERISTICS (25°C UNLESS NOTED)****Output Characteristics****Transfer Characteristics****Transconductance****On-Resistance vs. Drain Current****Capacitance****Gate Charge**

TYPICAL CHARACTERISTICS (25 °C UNLESS NOTED)

**THERMAL RATINGS****Maximum Avalanche and Drain Current
vs. Case Temperature****Safe Operating Area****Normalized Thermal Transient Impedance, Junction-to-Case**



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